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(54) SEMICONDUCTOR DEVICE

- (71) Applicant: SK hynix Inc., Gyeonggi-do (KR)
- (72) Inventors: **Dong Il SONG**, Gyeonggi-do (KR); Seung Hwan KIM, Gyeonggi-do (KR)
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(57)ABSTRACT

A semiconductor device includes a pair of word line separation slits; a word line stack disposed between the pair of the word line separation slits and including a plurality of word lines that are vertically stacked; a plurality of supporters disposed between the word line separation slits and supporting the word line stack; and contact plugs electrically connected to the word line stack.

